



DECLARATION FOR NON-PROVISIONAL PATENT APPLICATION*

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below at 201 et seq. underneath my name.

I believe I am the original, first and sole inventor if only one name is listed at 201 below, or an original, first and joint inventor if plural names are listed at 201 et seq. below, of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD FOR THE DEPOSITION OF MATERIALS FROM MESOMORPHOUS FILMS

and for which a patent application:

- is attached hereto and includes a Preliminary Amendment attached hereto *(if applicable)*
- was filed in the United States on June 8, 2001 as Application Serial No. 09/876,944 *(for declaration not accompanying application)*
- was filed as PCT international Application No. on and was amended under PCT Article 19 on *(if applicable)*

I hereby state that I have reviewed and understand the contents of the above identified application, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

EARLIEST FOREIGN APPLICATION(S), IF ANY, FILED PRIOR TO THE FILING DATE OF THE APPLICATION			
APPLICATION NUMBER	COUNTRY	DATE OF FILING (day, month, year)	PRIORITY CLAIMED
			YES <input type="checkbox"/> NO <input type="checkbox"/>
			YES <input type="checkbox"/> NO <input type="checkbox"/>
			YES <input type="checkbox"/> NO <input type="checkbox"/>

I hereby claim the benefit under Title 35, United States Code, §119(e) of any United States provisional application(s) listed below.

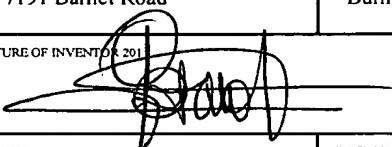
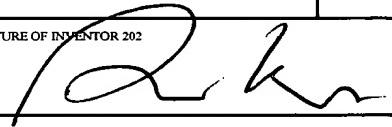
APPLICATION NUMBER	FILING DATE

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

APPLICATION SERIAL NO.	FILING DATE	STATUS		
		PATENTED	PENDING	ABANDONED
09/875,957	June 6, 2001		✓	

* for use only when the application is assigned to a company, partnership or other organization.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

2 0 1	FULL NAME OF INVENTOR	LAST NAME Bravo Vasquez	FIRST NAME Juan	MIDDLE NAME Pablo
	RESIDENCE & CITIZENSHIP	CITY Burnaby	STATE OR FOREIGN COUNTRY British Columbia, Canada	COUNTRY OF CITIZENSHIP Chile
	POST OFFICE ADDRESS	STREET 103 7191 Barnet Road	CITY Burnaby	STATE OR COUNTRY British Columbia, Canada
	SIGNATURE OF INVENTOR 201			DATE Aug 7 2001
2 0 2	FULL NAME OF INVENTOR	LAST NAME Hill	FIRST NAME Ross	MIDDLE NAME H.
	RESIDENCE & CITIZENSHIP	CITY Coquitlan	STATE OR FOREIGN COUNTRY British Columbia, Canada	COUNTRY OF CITIZENSHIP Canada
	POST OFFICE ADDRESS	STREET 294 Hart Street	CITY Coquitlan	STATE OR COUNTRY British Columbia, Canada
	SIGNATURE OF INVENTOR 202			DATE Aug. 7 2001